FAIRCHILD SEMICONDUCTOR™

July 2001
Revised January 2005

NC7SZ74
TinyLogic® UHS D-Type Flip-Flop with Preset and Clear

General Description

The NC7SZ74 is a single D-type CMOS Flip-Flop with preset and clear from Fairchild's Ultra High Speed Series of TinyLogic® in the space saving US8 package. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} range. The inputs and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage.

The signal level applied to the D input is transferred to the Q output during the positive going transition of the CLK pulse.

Features

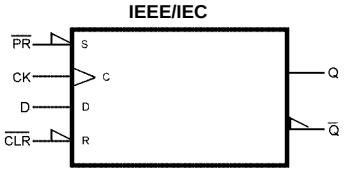
- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Ultra High Speed; t_{PD} 2.6 ns Typ into 50 pF at 5V V_{CC}
- High Output Drive; ± 24 mA at 3V V_{CC}
- Broad V_{CC} Operating Range; 1.65V to 5.5V
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZ74K8X	MAB08A	SZ74	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7SZ74L8X	MAC08A	N9	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

Logic Symbol



Pin Descriptions

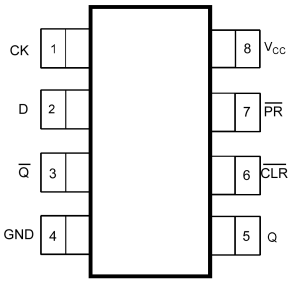
Pin Names	Description
D	Data Input
CK	Clock Pulse Input
$\overline{CLR}$	Direct Clear Input
Q, $\overline{Q}$	Flip-Flop Output
$\overline{PR}$	Direct Preset Input

Truth Table

Inputs				Outputs		Function
$\overline{CLR}$	$\overline{PR}$	D	CK	Q	$\overline{Q}$	
L	H	X	X	L	H	Clear
H	L	X	X	H	L	Preset
L	L	X	X	H	H	—
H	H	L	↑	L	H	—
H	H	H	↑	H	L	—
H	H	X	↓	Q_n	$\overline{Q}_n$	No Change

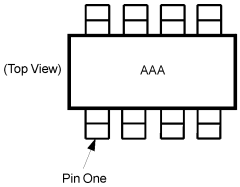
H = HIGH Logic Level
L = LOW Logic Level
Q_n = No change in data
Z = High Impedance
X = Immaterial
↑ = Rising Edge
↓ = Falling edge

Connection Diagrams



(Top View)

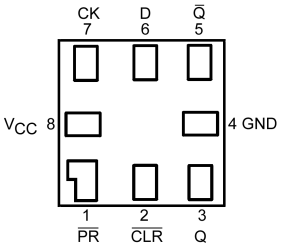
Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Input Voltage (V_{IN})	−0.5V to +7.0V
DC Output Voltage (V_{OUT})	−0.5V to +7.0V
DC Input Diode Current (I_{IK})	
V_{IN} < 0V	−50 mA
DC Output Diode Current (I_{OK})	
V_{OUT} < 0V	−50 mA
DC Output (I_{OUT}) Source/Sink Current	± 50 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	± 50 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Junction Temperature under Bias (T_J)	150°C
Junction Lead Temperature (T_L)	
(Soldering, 10 seconds)	260°C
Power Dissipation (P_D) @ +85°C	250 mW

Recommended Operating Conditions (Note 2)

Power Supply	
Operating (V_{CC})	1.65V to 5.5V
Data Retention	1.5V to 5.5V
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	
Active State	0V to V_{CC}
3-STATE	0V to 5.5V
Input Rise and Fall Time (t_r, t_f)	
V_{CC} = 1.8V, 2.5V ± 0.2V	0 to 20 ns/V
V_{CC} = 3.3V ± 0.3V	0 to 10 ns/V
V_{CC} = 5.5V ± 0.5V	0 to 5 ns/V
Operating Temperature (T_A)	−40°C to +85°C
Thermal Resistance (θ_{JA})	250° C/W

Note 1: Absolute Maximum Ratings: are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	T_A = +25°C			T_A = −40°C to +85°C		Units	Conditions	
			Min	Typ	Max	Min	Max			
V_{IH}	HIGH Level Control Input Voltage	1.65 to 1.95	0.75 V_{CC}			0.75 V_{CC}		V		
		2.3 to 5.5	0.75 V_{CC}			0.7 V_{CC}				
V_{IL}	LOW Level Control Input Voltage	1.65 to 1.95			0.25 V_{CC}		0.25 V_{CC}	V		
		2.3 to 5.5			0.3 V_{CC}		0.3 V_{CC}			
V_{OH}	HIGH Level Control Output Voltage	1.65	1.55	1.65		1.55				
		2.3	2.2	2.3		2.2				I_{OH} = −100 µA
		3.0	2.9	3.0		2.9				
		4.5	4.4	4.5		4.4				
		1.65	1.29	1.52		1.29		V	V_{IN} = V_{IH}	I_{OH} = −4 mA
		2.3	1.9	2.15		1.9				I_{OH} = −8 mA
		3.0	2.4	2.8		2.4				I_{OH} = −16 mA
		3.0	2.3	2.68		2.3				I_{OH} = −24 mA
		4.5	3.8	4.2		3.8				I_{OH} = −32 mA
V_{OL}	LOW Level Control Output Voltage	1.65			0.1		0.1			
		2.3			0.1		0.1			I_{OL} = 100 µA
		3.0			0.1		0.1			
		4.5			0.1		0.1			
		1.65		0.08	0.24		0.24	V	V_{IN} = V_{IH}	I_{OL} = 4 mA
		2.3		0.10	0.3		0.3			I_{OL} = 8 mA
		3.0		0.15	0.4		0.4			I_{OL} = 16 mA
		3.0		0.22	0.55		0.55			I_{OL} = 24 mA
		4.5		0.22	0.55		0.55			I_{OL} = 32 mA
I_{IN}	Input Leakage Current	0 to 5.5			±0.1		±1.0	µA	0 ≤ V_{IN} ≤ 5.5V	
I_{OFF}	Power Off Leakage Current	0.0			1.0		10	µA	V_{IN} or V_{OUT} = 5.5V	
I_{CC}	Quiescent Supply Current	1.65 to 5.5			1.0		10.0	µA	V_{IN} = 5.5V, GND	

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = +25°C$			$T_A = -40°C$ to $+85°C$		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
f_{MAX}	Maximum Clock Frequency	1.8 ± 0.15	75			75		MHz	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 5
		2.5 ± 0.2	150			150				
		3.3 ± 0.3	200			200				
		5.0 ± 0.5	250			250				
		3.3 ± 0.3	175			175			C_L = 50 pF, R_D = 500Ω, S_1 = Open	
		5.0 ± 0.5	200			200				
t_{PLH} t_{PHL}	Propagation Delay CK to Q, $\overline{Q}$	1.8 ± 0.15	2.5	6.5	12.5	2.5	13.0	ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 3
		2.5 ± 0.2	1.5	3.8	7.5	1.5	8.0			
		3.3 ± 0.3	1.0	2.8	6.5	1.0	7.0			
		5.0 ± 0.5	0.8	2.2	4.5	0.8	5.0			
		3.3 ± 0.3	1.0	3.4	7.0	1.0	7.5		C_L = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	1.0	2.6	5.0	1.0	5.5			
t_{PLH} t_{PHL}	Propagation Delay $\overline{CLR}$, $\overline{PR}$, to Q, $\overline{Q}$	1.8 ± 0.15	2.5	6.5	14.0	2.5	14.5	ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 3
		2.5 ± 0.2	1.5	3.8	9.0	1.5	9.5			
		3.3 ± 0.3	1.0	2.8	6.5	1.0	7.0			
		5.0 ± 0.5	0.8	2.2	5.0	0.8	5.5			
		3.3 ± 0.3	1.0	3.4	7.0	1.0	7.5		C_L = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	1.0	2.6	5.0	1.0	5.5			
t_S	Setup Time, CK to D	1.8 ± 0.15	6.5			6.5		ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 4
		2.5 ± 0.2	3.5			3.5				
		3.3 ± 0.3	2.0			2.0				
		5.0 ± 0.5	1.5			1.5				
		3.3 ± 0.3	2.0			2.0			C_L = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	1.5			1.5				
t_H	Hold Time, CK to D	1.8 ± 0.15	0.5			0.5		ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 4
		2.5 ± 0.2	0.5			0.5				
		3.3 ± 0.3	0.5			0.5				
		5.0 ± 0.5	0.5			0.5				
		3.3 ± 0.3	0.5			0.5			C_L = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	0.5			0.5				
t_W	Pulse Width, CK, $\overline{PR}$, $\overline{CLR}$	1.8 ± 0.15	6.0			6.0		ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 5
		2.5 ± 0.2	4.0			4.0				
		3.3 ± 0.3	3.0			3.0				
		5.0 ± 0.5	2.0			2.0				
		3.3 ± 0.3	3.0			3.0			CL = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	2.0			2.0				
t_{REC}	Recover Time $\overline{CLR}$, $\overline{PR}$ to CK	1.8 ± 0.15	8.0			8.0		ns	C_L = 15 pF, R_D = 1 MΩ, S_1 = Open	Figures 1, 4
		2.5 ± 0.2	4.5			4.5				
		3.3 ± 0.3	3.0			3.0				
		5.0 ± 0.5	3.0			3.0				
		3.3 ± 0.3	3.0			3.0			C_L = 50 pF, R_D = 500 Ω, S_1 = Open	
		5.0 ± 0.5	3.0			3.0				

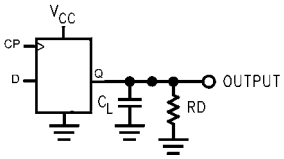
Capacitance (Note 3)

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Input Capacitance	3		pF	V_{CC} = 0V
C_{OUT}	Output Capacitance	4		pF	V_{CC} = 0V
C_{PD}	Power Dissipation Capacitance (Note 4)	10		pF	V_{CC} = 3.3V
		12			V_{CC} = 5.0V

Note 3: T_A = +25C, f = 1MHz.

Note 4: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})\ (V_{CC})\ (f_{IN}) + (I_{CC}static)$.

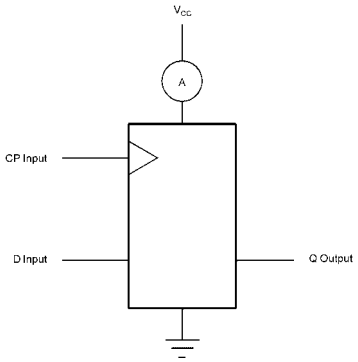
AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz; t_w = 500 ns

FIGURE 1. AC Test Circuit



CP Input = AC Waveform; $t_r = t_f$ = 2.5 ns;

CP Input PRR = 10 MHz; Duty Cycle = 50%

D Input PRR = 5MHz; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

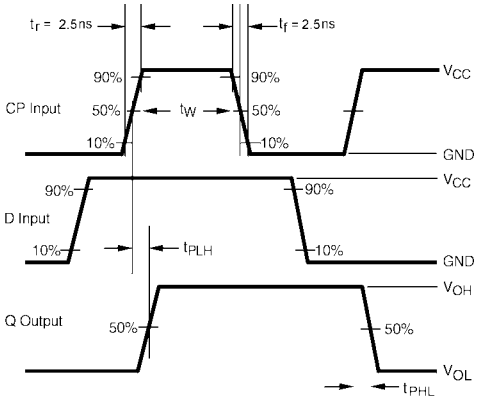


FIGURE 3. AC Waveforms

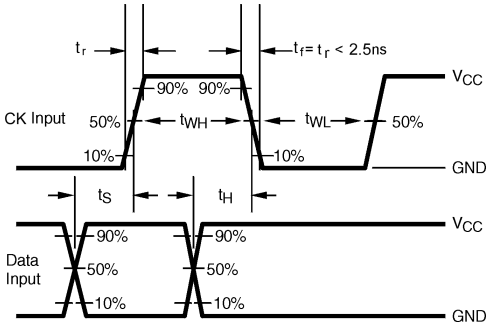


FIGURE 4. AC Waveforms

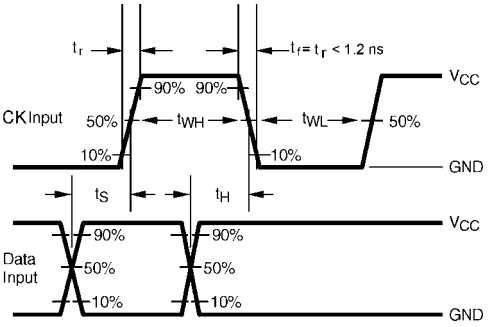


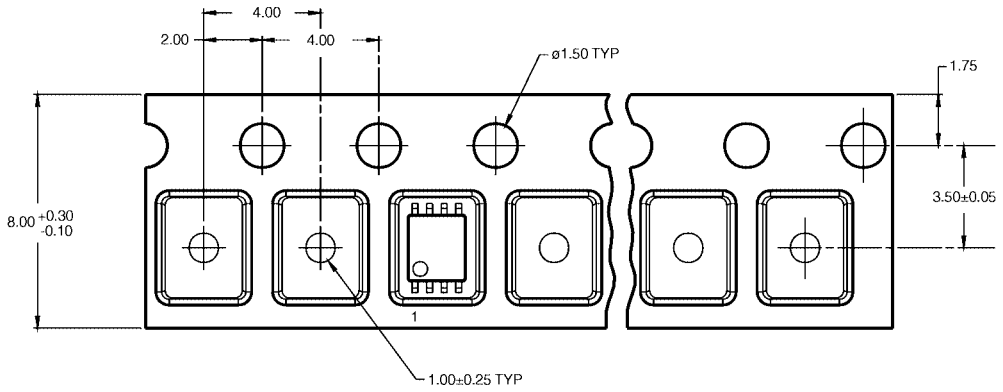
FIGURE 5. AC Waveforms

Tape and Reel Specification

TAPE FORMAT for US8

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
K8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

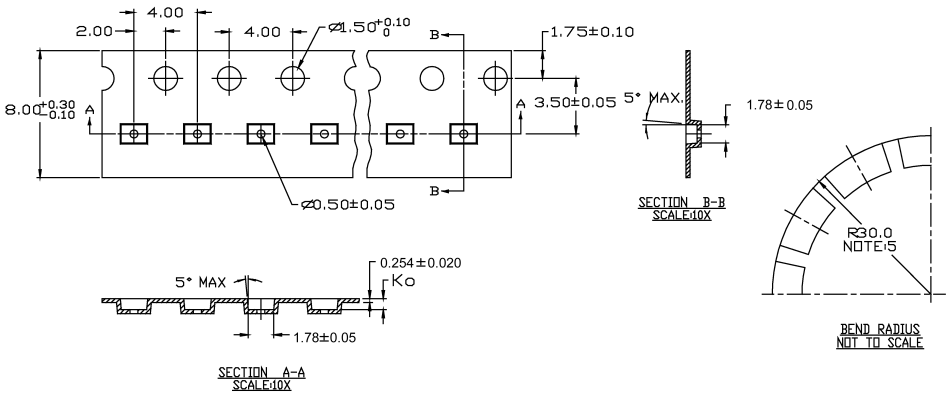
TAPE DIMENSIONS inches (millimeters)



TAPE FORMAT for MicroPak

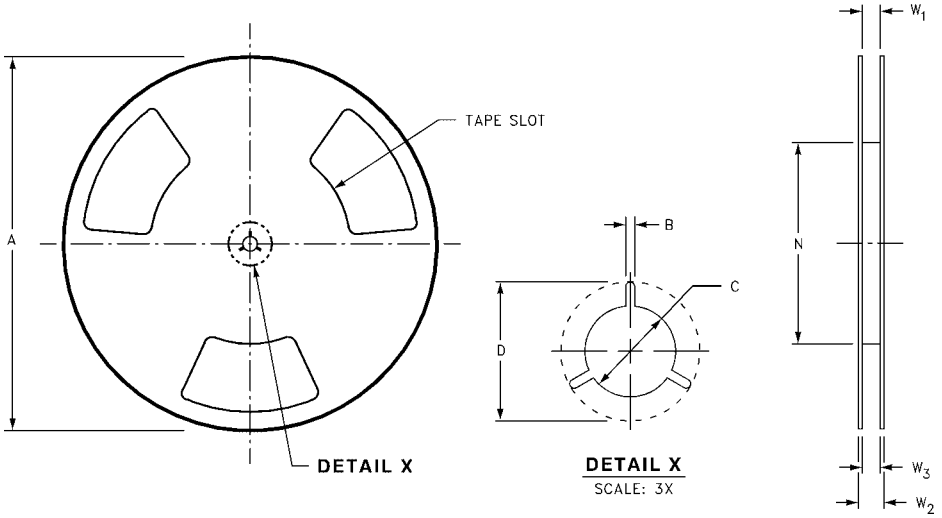
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



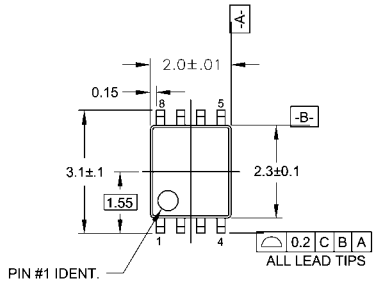
Tape and Reel Specification (Continued)

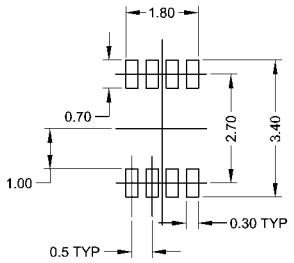
REEL DIMENSIONS inches (millimeters)



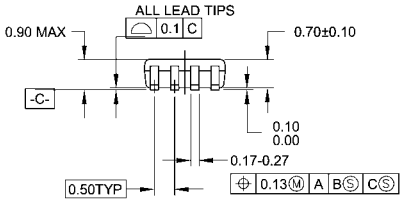
Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/–0.000 (8.40 + 1.50/–0.00)	0.567 (14.40)	W1 + 0.078/–0.039 (W1 + 2.00/–1.00)

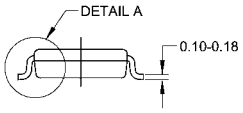
Physical Dimensions inches (millimeters) unless otherwise noted

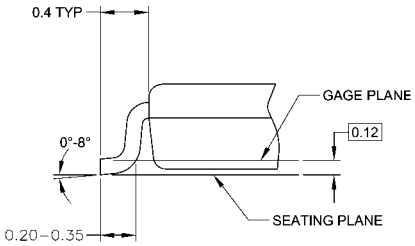




LAND PATTERN RECOMMENDATION







DETAIL A

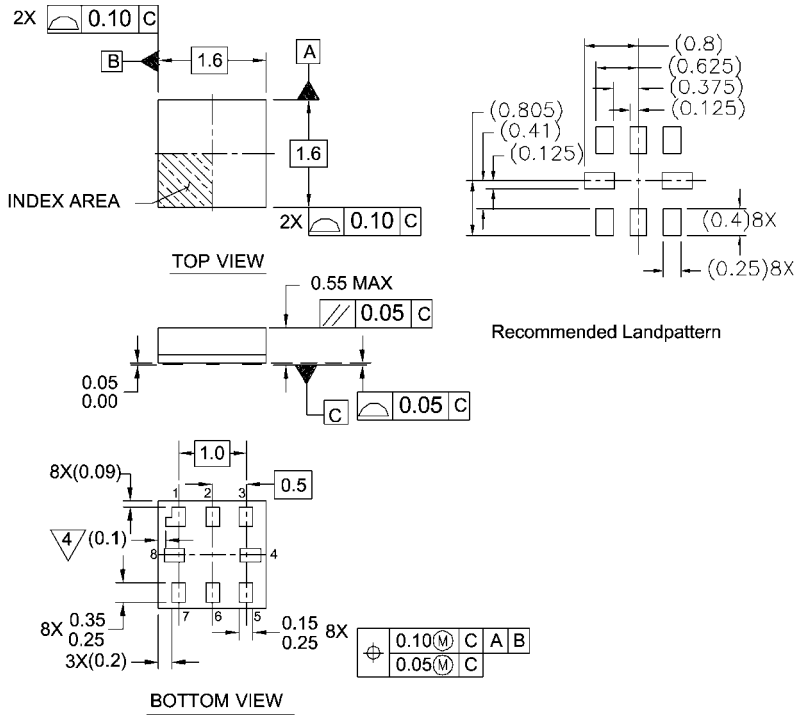
NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-187
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide
Package Number MAB08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

Pb-Free 8-Lead MicroPak, 1.6 mm Wide
Package Number MAC08A

LIFE SUPPORT POLICY

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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